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PDWG.NO: 0366-2

APPD.	JM_Zheng	NAME:
CHKD.	LYX	TYPE-C 14P 母座 直立式 H=11.0 外壳无弹 四脚插 端子DIP( C款 )
DR.	TSP	P.J. NO.: UC.01.14-1W-0002
		SIZE: A4 DRW NO.:
		FINISH: SEE NOTES MAT'L.: SEE NOTES
		SCALE: N/A REV.: AO UNIT: mm PAGE: 1/2

**深圳市步步精科技有限公司**

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特性:

- 一、电气性能: ELECTRICAL
  1. 额定电流: 5.0A
  2. 接触阻抗: 30 MILLIOHMS MAX
  3. 耐电压: 150V AC / 1 mA MAX
  4. 绝缘阻抗: 150V DC/100 MEGA OHMS MIN

二、机械性能:

1. 插入力: 5~20N
2. 拨出力: 8~20N
3. 使用寿命: 10000次、拔出力 6~20N

三、材料: MATERIAL

1. 塑胶: PA97蓝色(PT298C) UL94V-0
2. 端子: C7025 T=0.20MM
3. 外壳: SUS304 T=0.30MM
4. 卡勾: SUS304 T=0.15MM

四、电镀: FINISH

1. 端子: 接触点镀金3U"MIN  
PIN脚焊接区域镀金1U"MIN.
2. 外壳: 镀镍50U"MIN (盐雾48H)

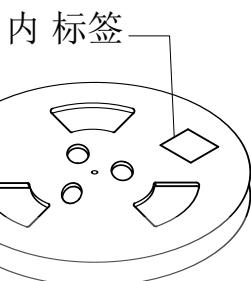
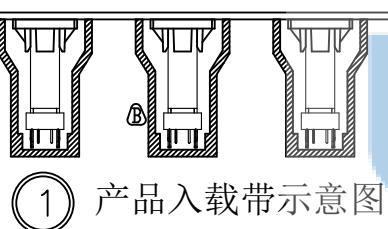
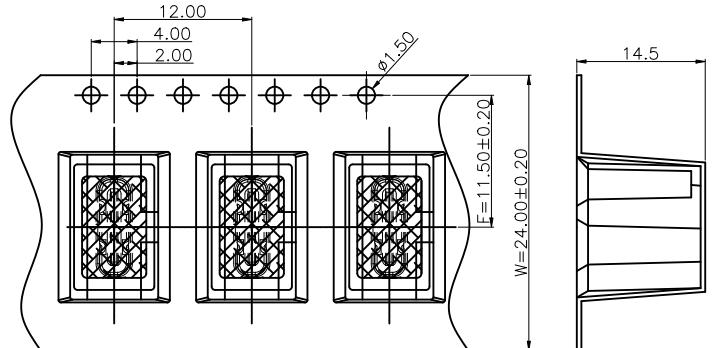
五、电镀品需做粘锡测试: 粘锡面积达到95%以上。  
六、SMT回流焊 (峰值260° C±5° C) 不能起泡、  
熔胶、变色不良 (变形在公差范围以内)

七、工作温度: -40° C~+85° C

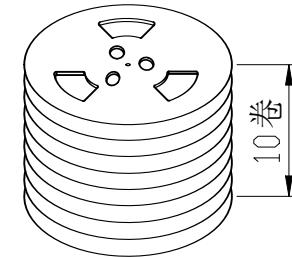
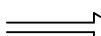


A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1		
A6	D+	B7	D-
A7	D-	B6	D+
		B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

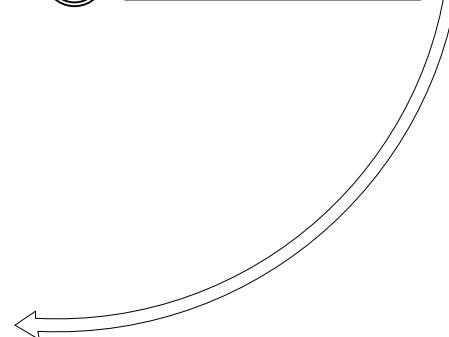
REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0				



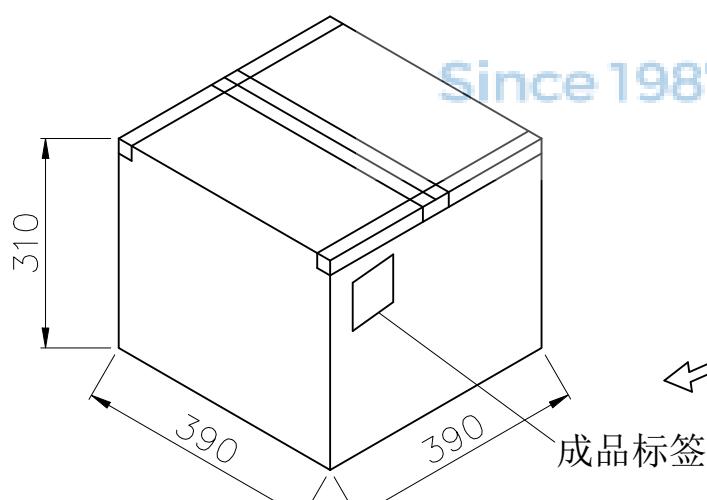
② 卷盘贴标签示意图



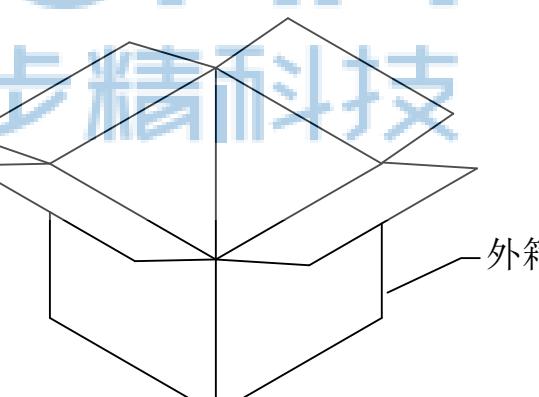
③ 10盘产品叠层示意图



⑤ 外箱封箱示意图



Since 1987



④ 产品入外箱示意图



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NAME:  
TYPE-C 14P 母座 直立式 H=11.0 外壳无弹 四脚插 端子DIP(款)

.X: ±0.38	X: ±3'	APPD: JM_Zheng	P.J. NO.: UC.01.14-1W-0002
.XX: ±0.25	X: ±2'	CHKD: LYX	SIZE: A4 DRW NO.:
.XXX: ±0.13	X: ±1'	DR: TSP	FINISH: SEE NOTES MAT'L.: SEE NOTES
			SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/2